FP1105

High current power inductors



Product features

- 11.0 x 8.0 x 4.90mm surface mount package
- Ferrite core material
- · High current carrying capacity
- Low core losses
- Controlled DCR tolerance for sensing circuits
- Inductance range from 101nH to 226nH
- Current range from 39 to 81Amps
- Frequency range up to 2MHz
- · Halogen free, lead free, RoHS compliant

Applications

- Multi-phase regulators
- Voltage Regulator Module (VRM)
- Portable electronics
- Servers and workstations
- Data networking and storage systems
- Notebook and desktop computers
- Graphics cards and battery power systems
- DCR sensing

Environmental data

- Storage temperature range (component): -40 °C to +125 °C
- Operating temperature range: -40 °C to +125 °C (ambient plus self-temperature rise)
- Solder reflow temperature:
 J-STD-020 (latest revision) compliant





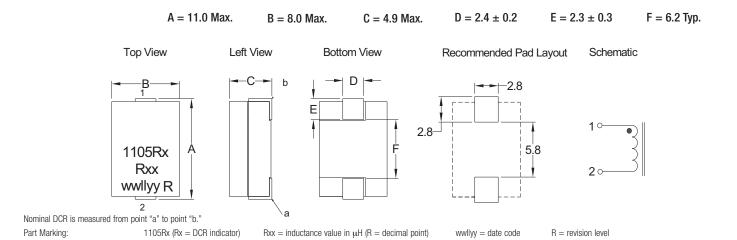




	Product Specifications						
Part Number	OCL1 ± 10% (nH)	FLL ² Min. (nH)	I _{rms} ³ (Amps)	I _{sat} 1 ⁴ @ 25°C (Amps)	I _{sat} 2 ⁵ @ 125°C (Amps)	DCR (mΩ) @ 20°C	K-factor ⁶
FP1105R1-R10-R	100	72		81	63		467
FP1105R1-R12-R	120	86		66	50		467
FP1105R1-R15-R	150	109	46	54	42	0.35 ± 8.6%	467
FP1105R1-R20-R	192	138		42	34		467
FP1105R1-R22-R	226	163		39	28		467

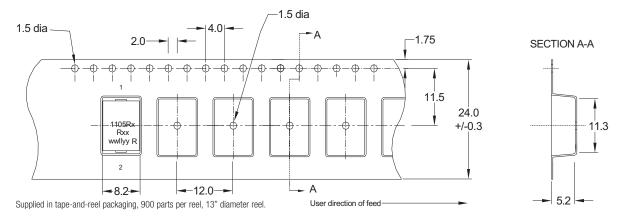
- 1 Open Circuit Inductance (OCL) Test Parameters: 100kHz, $0.10V_{\mbox{rms}}$, $0.0\mbox{Adc}$
- 2 Full Load Inductance (FLL) Test Parameters: 100kHz, 0.1V_{rms}, I_{sat}1
- 3 $\,$ I $_{rms}$: DC current for an approximate temperature rise of 40°C without core loss. Derating is necessary for AC currents. PCB pad layout, trace thickness and width, air-flow and proximity of other heat generating components will affect the temperature rise. It is recommended the part temperature not exceed 125°C under worst case operating conditions verified in the end application.
- 4 I_{sat} 1: Peak current for approximately 20% rolloff at +25°C.
- 5 I_{sat}2: Peak current for approximately 20% rolloff at +125°C.
- 6 K-factor: Used to determine B_{p-p} for core loss (see graph). $B_{p-p} = K \star L \star \Delta I \star 10^{-3}$, B_{p-p} : (Gauss), K: (K-factor from table), L: (inductance in nH), ΔI (peak-to-peak ripple current in amps).
- 7 Part Number Definition: FP1105Rx-Rxx-R
 - FP1105 = Product code and size
- Rx is the DCR indicator
- Rxx= Inductance value in μH, R = decimal point
 "-R" suffix = RoHS compliant

Dimensions- mm

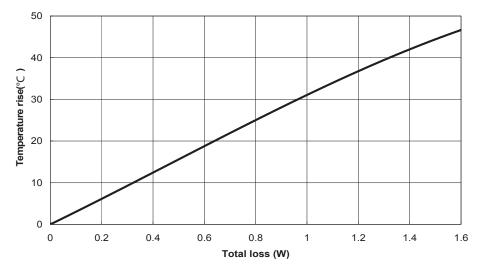


Packaging information - mm

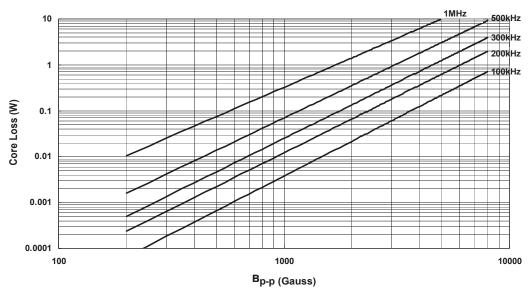
Packaging Information - mm



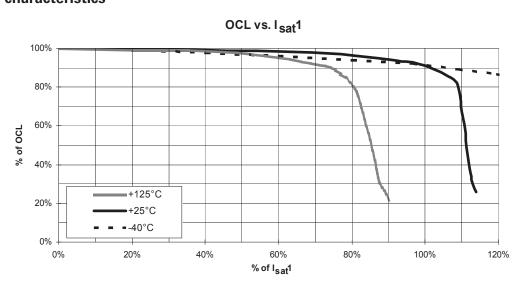
Temperature rise vs. total loss



Core Loss vs Bp-p



Inductance characteristics



Solder Reflow Profile

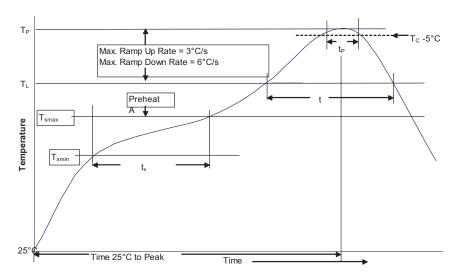


Table 1 - Standard SnPb Solder (T_c)

	Volume	Volume
Package	mm³	mm³
Thickness	<350	≥350
<2.5mm	235°C	220°C
≥2.5mm	220°C	220°C

Table 2 - Lead (Pb) Free Solder (Tc)

Package	Volume mm³	Volume mm³	Volume mm³
Thickness	<350	350 - 2000	>2000
<1.6mm	260°C	260°C	260°C
1.6 - 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

Reference JDEC J-STD-020

Profile Feature		Standard SnPb Solder	Lead (Pb) Free Solder	
Preheat and Soak	• Temperature min. (T _{smin})	100°C	150°C	
	Temperature max. (T _{smax})	150°C	200°C	
	• Time (T _{smin} to T _{smax}) (t _s)	60-120 Seconds	60-120 Seconds	
Average ramp up rate T _{smax} to T _p		3°C/ Second Max.	3°C/ Second Max.	
Liquidous temperature (TL)		183°C	217°C	
Time at liquidous (t _L)		60-150 Seconds	60-150 Seconds	
Peak package body temperature (Tp)*		Table 1	Table 2	
Time $(t_p)^{**}$ within 5 °C of the specified classification temperature (T_c)		20 Seconds**	30 Seconds**	
Average ramp-down rate (T _p to T _{smax})		6°C/ Second Max.	6°C/ Second Max.	
Time 25°C to Peak Temperature		6 Minutes Max.	8 Minutes Max.	

 $^{^{\}star}$ Tolerance for peak profile temperature (Tp) is defined as a supplier minimum and a user maximum.

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^{**} Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.

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